



PRODUCT DATASHEET



- Ceramic High Power
- 3939 2.56t Series
- ▶ UV (250~260nm)





N0Q56S58Z

APPLICATIONS:

- Disinfection
- Sterilization
- Bio-Analysis
- Detection

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- Sensor Light
- Fluorescent Spectroscopy

3939 2.56t Series



FEATURES:

- Package: Ceramic SMT Package with Quartz Glass Lens
- Forward Current: 350mA
- Forward Voltage (typ.): 7.0V
- Radiant Power (typ.): 60mW@350mA
- Colour: Ultraviolet (UV)
- Wavelength: 250~260nm
- Viewing angle: 60°
- Materials:
 - Die: InGaN
 - Resin: Quartz Glass (Water Clear)
 - L/F: AIN
- Junction Temperature: +85°C
- Operating Temperature: -30~+60°C
- Storage Temperature: -40~+100°C
- Grouping parameters:
 - Forward voltage
 - Radiant power
 - Peak Wavelength
- Soldering methods: Reflow soldering
- MSL: Level 4 according to J-STD020
- Packing: 12mm tape with min.100pcs/reel, ø180mm (7")





Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Maximum Forward Current	I _{MAX}	350	mA
Junction Temperature	Tj	85	°C
Thermal Resistance Junction to Solder Point	Rтнлs	12.5	°C/W
Junction Temperature	τ	85	°C
Operating Temperature	Topr	-30~+60	°C
Storage Temperature	Тѕтб	-40~+100	°C
Electrostatic Discharge	ESD	2000	V
Solder Temperature	T _{SOL}	245	°C

Electrical & Optical Characteristics (Ta=25°C)

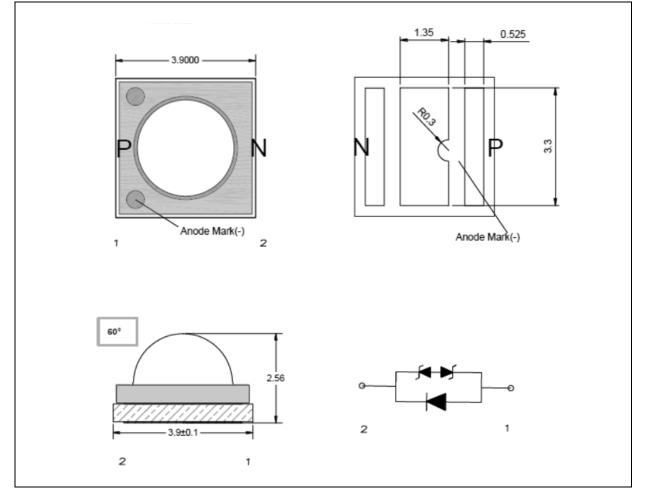
Parameter	Sumbol	Values			Lloit	Test
	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	VF	6.0		8.0	V	I⊧=350mA
Radiant Power	Po	40		80	mW	I _F =350mA
Wavelength	Wp	250		260	nm	I⊧=350mA
Viewing Angle	20 _{1/2}		60		deg	I⊧=350mA

1. Radiant Power (P₀) ±10%, Forward Voltage (V_F) ±0.2V, Viewing angle($2\theta_{1/2}$) ±10°, Wavelength (nm) ±2nm



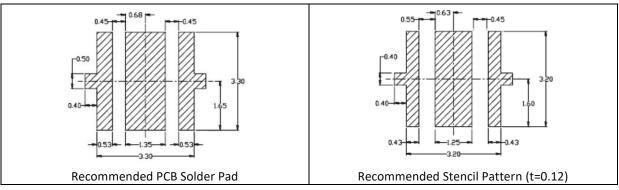


Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ± 0.13 mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.13 mm with angle tolerance $\pm 0.5^{\circ}$.





Forward Voltage Classifications (I_F = 350mA):

Code	Min.	Max.	Unit
V1	6.0	8.0	V

Radiant Power Classifications (I_F = 350mA):

Code	Min.	Max.	Unit
H1	40	60	
H2	60	80	mW

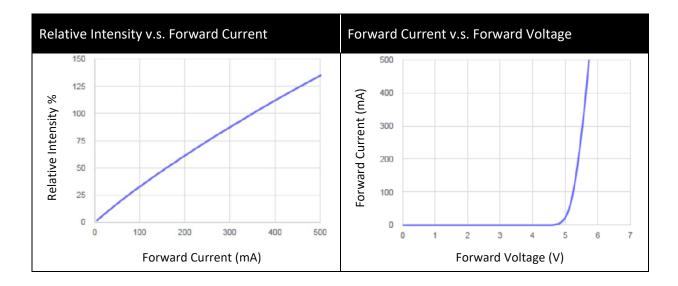
Wavelength Classifications (I_F = 350mA):

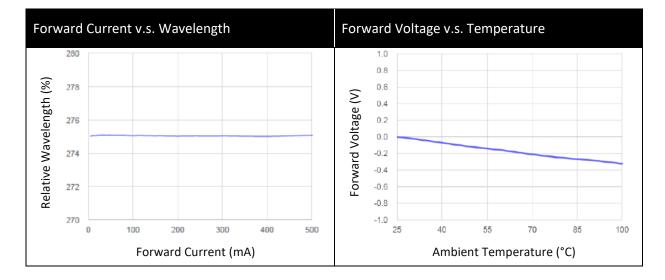
Code	Min.	Max.	Unit
UVC255	250	260	nm

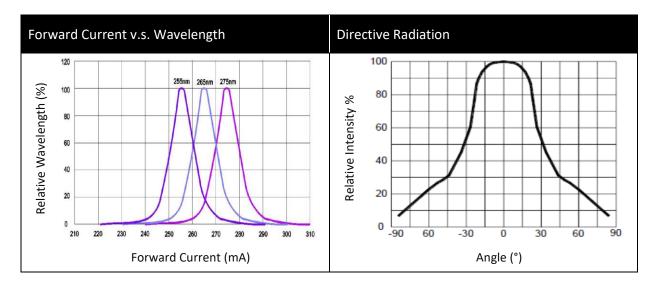




ELECTRO-OPTICAL CHARACTERISTICS:





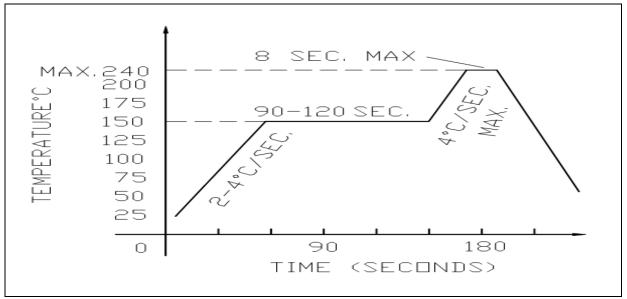






RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



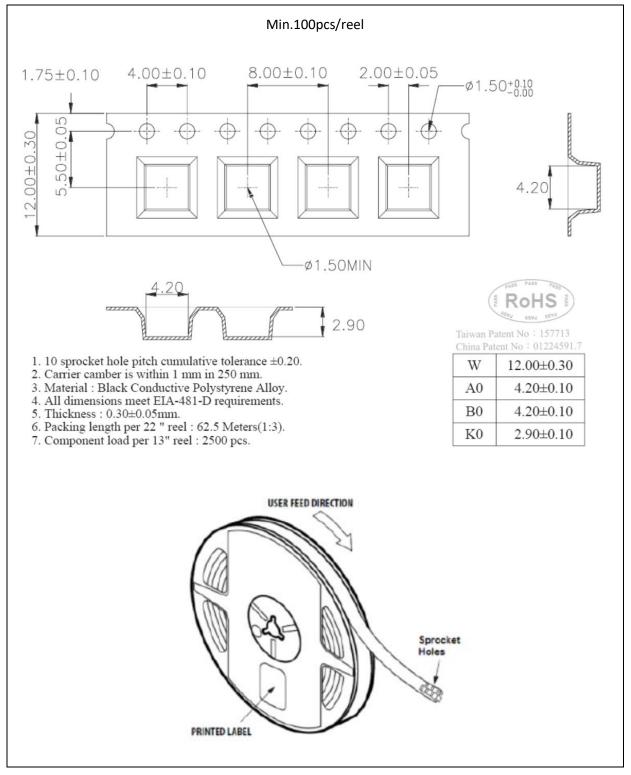
Note:

- 1. Maximum reflow soldering: 1 time.
- 2. Recommended reflow temperature 240°C. Maximum soldering temperature should be limited to 245°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.





Reel Dimension:







Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within 72 hours. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

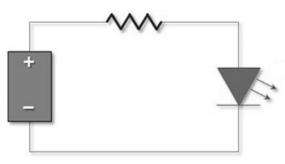
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 12hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.

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REVISION RECORD:

Version	Date	Summary of Revision
A1.0	21/11/2020	Datasheet set-up.
A1.1	11/11/2021	New datasheet format.
A1.2	04/12/2022	Update radiant power value.

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